2007777-2 - ACTIVE

IMPACT

TE Internal #: 2007777-2 High Speed Backplane Connectors, 90 Position, Mating Alignment, Keyed Mating Alignment Type, 9 Row, 10 Column, PCB Mount Header, Vertical, IMPACT

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: Board-to-Board

Number of Positions: 90

Row-to-Row Spacing: 1.35 mm [.053 in]

Mating Alignment: With

Mating Alignment Type: Keyed

Features

Product Type Features

Signal ArrangementDifferentialConnector SystemBoard-to-BoardPCB Connector Assembly TypePCB Mount Header

Shroud Style	Partially Shrouded	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Ground Positions	30	
Number of Pairs	30	
Stackable	No	
Number of Signal Positions	60	
Number of Positions	90	
Number of Rows	9	
Number of Columns	10	
PCB Mount Orientation	Vertical	
Guide Location	Left	
Electrical Characteristics		
Impedance	100 Ω	
Operating Voltage	30 VAC	

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Signal Characteristics

Number of Differential Pairs per Column	3	
Data Rate	20 – 25 Gb/s	
Body Features		
Primary Product Color	Black	
Contact Features		
Contact Mating Area Length	4.9 mm[.193 in]	
PCB Contact Termination Area Plating Material Thickness	.76 – 1.52 μm[30 – 60 μin]	
Contact Layout	Inline	
Contact Type	Pin	
Contact Underplating Material Thickness	1.27 μm[50 μin]	
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]	
Contact Mating Area Plating Material	Gold	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Dual Beam	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Copper Alloy	
Contact Current Rating (Max)	.75 A	
Termination Features		
Termination Post & Tail Length	1.4 mm[.055 in]	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit	
Vechanical Attachment		
Guide Hardware	Without	
Mating Retention	Without	
PCB Mount Retention	With	
PCB Mount Retention Type	Action/Compliant Tail & Screw	
Mating Alignment	With	
Mating Alignment Type	Keyed	
Connector Mounting Type	Board Mount	
Housing Features		

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End Wall Location	Open	
Housing Material	LCP - GF (Liquid Crystal Polymer)	
Centerline (Pitch)	1.9 mm[.075 in]	
Dimensions		
Connector Length	25.5 mm[1.004 in]	
Connector Height	24.6 mm[.969 in]	
Connector Width	16.7 mm[.657 in]	
PCB Thickness (Recommended)	1 mm	
PCB Hole Diameter	.39 mm[.015 in]	
Row-to-Row Spacing	1.35 mm[.053 in]	
Usage Conditions		
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA Certified, UL E28476	
UL Flammability Rating	UL 94V-0	

Packaging Features

Packaging Method

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free	
Solder Process Capability	Not applicable for solder process capability	

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Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

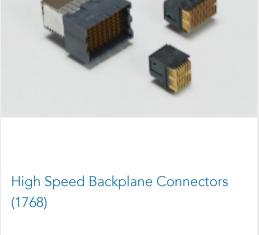
Compatible Parts



TE Part # 2007705-1 IMP100S,R,RA3P10C,UG,39

Also in the Series IMPACT





Customers Also Bought



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TE Part #2-1617028-2	TE Part #1616993-2	TE Part #72529-09-35PN	TE Part #1616005-7
HFW1102K05 = HFW 1/2 SIZE RELA	KAL290KS=CONTACTOR	HERM RECP	B434=RELAY

Documents

Product Drawings IMP100S,H,V3P10C,LG,OEW39,4.9

English

CAD Files

Customer View Model ENG_CVM_CVM_2007777-2_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2007777-2_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2007777-2_B.3d_stp.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

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Agency Approvals Agency Approval Document

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